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--73. The method of manufacturing a substrate as defined in claim 67, after adhering the conductive member, further comprising providing an adhesive in which an anisotropic conductive material having conductive particles dispersed.--

REMARKS

Claims 53-73 are pending. By this Supplemental Preliminary Amendment, claims 1-52 are canceled without prejudice or disclaimer, and claims 53-73 are added.

Prompt and favorable examination on the merits is respectfully requested.

Respectfully submitted,



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